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## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

## IGBT Module

### Sixpack

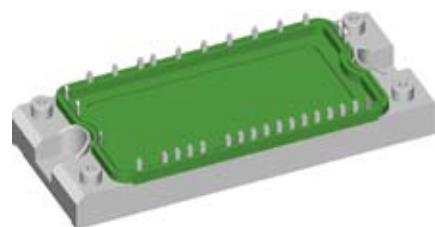
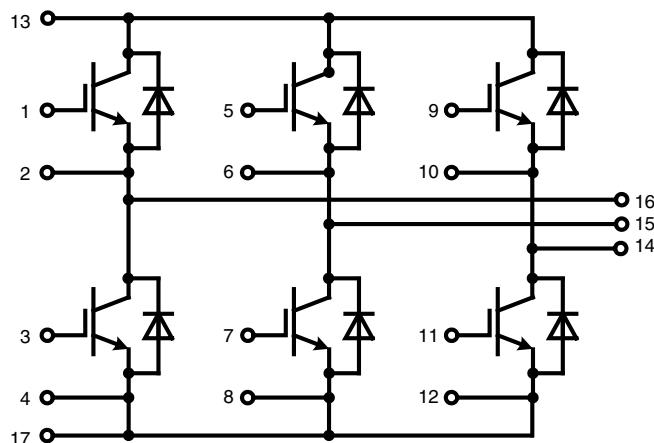
Short Circuit SOA Capability

Square RBSOA

$I_{C25}$  = 30 A  
 $V_{CES}$  = 1200 V  
 $V_{CE(sat)}$  typ. = 2.0 V

**Part name** (Marking on product)

MWI15-12A7



E72873

Pin configuration see outlines.

#### Features:

- NPT IGBT technology
- low saturation voltage
- positive temperature coefficient for easy paralleling
- low switching losses
- switching frequency up to 30 kHz
- square RBSOA, no latch up
- high short circuit capability
- MOS input, voltage controlled
- ultra fast free wheeling diodes
- solderable pins for PCB mounting
- space savings
- reduced protection circuits

#### Application:

- AC motor control
- AC servo and robot drives power supplies

#### Package:

- UL registered
- Industry standard E2-pack
- package with copper base plate
- package designed for wave soldering

## IGBTs

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{CES}$	collector emitter voltage	$T_{VJ} = 25^\circ\text{C}$ to $150^\circ\text{C}$		1200		V
$V_{GES}$	max. DC gate voltage	continuous		$\pm 20$		V
$V_{GEM}$	max. transient collector gate voltage	transient		$\pm 30$		V
$I_{C25}$	collector current	$T_C = 25^\circ\text{C}$	30			A
$I_{C80}$		$T_C = 80^\circ\text{C}$	20			A
$P_{tot}$	total power dissipation	$T_C = 25^\circ\text{C}$	140			W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 15 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	2.0 2.3	2.6	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.6 \text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	4.5	6.5	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		0.9	mA
$I_{GES}$	gate emitter leakage current	$V_{CE} = 0 \text{ V}; V_{GE} = \pm 20 \text{ V}$			200	nA
$C_{ies}$	input capacitance	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$		1000		pF
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 15 \text{ A}$		70		nC
$t_{d(on)}$	turn-on delay time	$T_{VJ} = 125^\circ\text{C}$ $V_{CE} = 600 \text{ V}; I_C = 15 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 82 \Omega$	100			ns
$t_r$	current rise time		75			ns
$t_{d(off)}$	turn-off delay time		500			ns
$t_f$	current fall time		70			ns
$E_{on}$	turn-on energy per pulse		2.3			mJ
$E_{off}$	turn-off energy per pulse		1.8			mJ
$I_{CM}$	reverse bias safe operating area	$RBSOA; V_{GE} = \pm 15 \text{ V}; R_G = 82 \Omega$ $L = 100 \mu\text{H}; \text{clamped induct. load}$ $V_{CEmax} = V_{CES} - L_s \cdot di/dt$	35			A
$t_{sc}$ (SCSOA)	short circuit safe operating area	$V_{CE} = V_{CES}; V_{GE} = \pm 15 \text{ V}; R_G = 82 \Omega; \text{non-repetitive}$	$T_{VJ} = 125^\circ\text{C}$	10		μs
$R_{thJC}$	thermal resistance junction to case	(per IGBT)			0.88	K/W

## Diodes

## Ratings

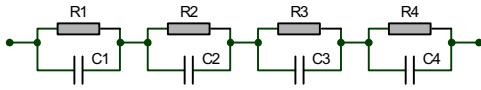
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 150^\circ\text{C}$		1200		V
$I_{F25}$	forward current	$T_C = 25^\circ\text{C}$		25		A
$I_{F80}$		$T_C = 80^\circ\text{C}$		17		A
$V_F$	forward voltage	$I_F = 15 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	2.4 1.7	2.7	V
$I_{RM}$	max. reverse recovery current	$V_R = 600 \text{ V}$ $di_F/dt = -400 \text{ A}/\mu\text{s}$ $I_F = 15 \text{ A}; V_{GE} = 0 \text{ V}$	16			A
$t_{rr}$	reverse recovery time		130			ns
$E_{rec(off)}$	reverse recovery energy		0.49			mJ
$R_{thJC}$	thermal resistance junction to case	(per diode)			2.1	K/W

 $T_C = 25^\circ\text{C}$  unless otherwise stated

**Module****Ratings**

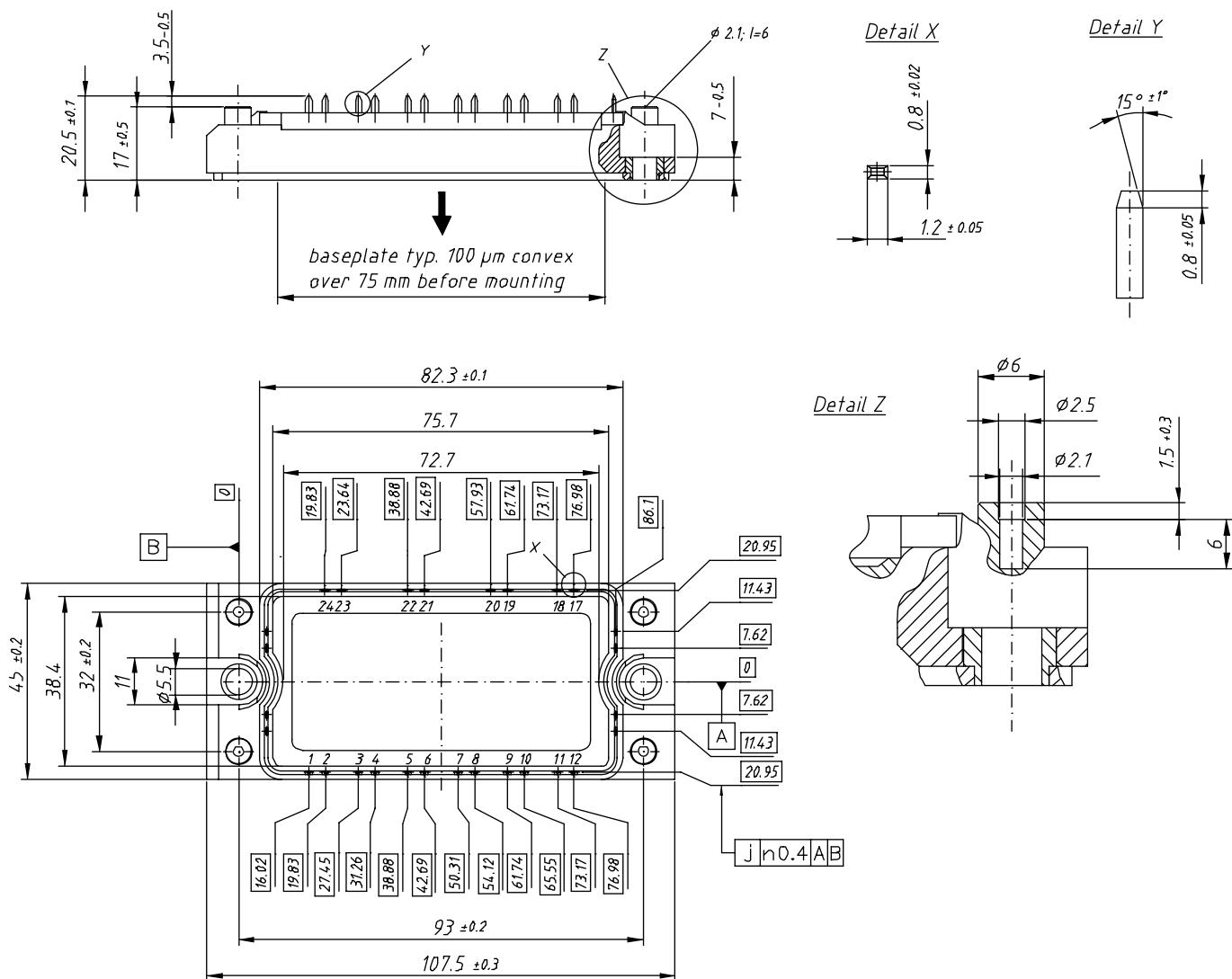
<b>Symbol</b>	<b>Definitions</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Unit</b>
$T_{VJ}$	<i>operating temperature</i>		-40		125	°C
$T_{VJM}$	<i>max. virtual junction temperature</i>				150	°C
$T_{stg}$	<i>storage temperature</i>		-40		125	°C
$V_{ISOL}$	<i>isolation voltage</i>	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$			2500	V~
$M_d$	<i>mounting torque</i>	(M4)	2.7		3.3	Nm
$d_s$	<i>creep distance on surface</i>		6			mm
$d_A$	<i>strike distance through air</i>		6			mm
<b>Weight</b>				180		g
$R_{thCH}$	<i>thermal resistance case to heatsink</i>	with heatsink compound	0.02			K/W

**Equivalent Circuits for Simulation****Ratings**

<b>Symbol</b>	<b>Definitions</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Unit</b>
$V_0$	<i>IGBT</i>	T1 - T6		$T_{VJ} = 125^\circ\text{C}$	1.37	V
$R_0$				62		mΩ
$V_0$	<i>Diode</i>	D1 - D6		$T_{VJ} = 125^\circ\text{C}$	1.327	V
$R_0$				30		mΩ
$R_1$	 $Z_{th}(t) = \sum_{i=1}^n \left[ R_i \cdot \left( 1 - \exp\left(-\frac{t}{\tau_i}\right) \right) \right]$ $\tau_i = R_i \cdot C_i$					
$R_2$						
$C_1$						
$C_2$						
					<b>IGBT</b>	<b>Diode</b>
					-	-
					-	-
					-	-

## Outline Drawing

Dimensions in mm (1 mm = 0.0394")



## Product Marking

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MWI 15-12A7	MWI15-12A7	Box	10	485063

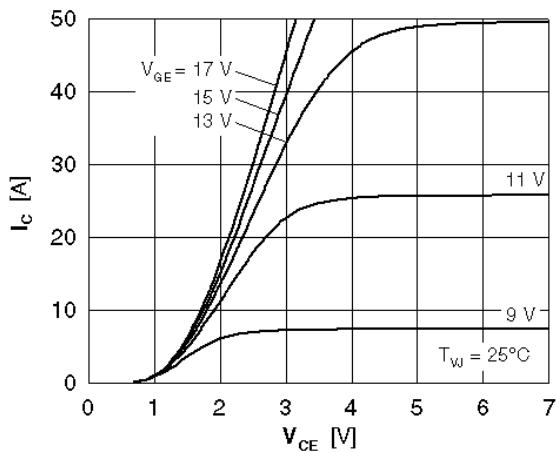


Fig. 1 Typ. output characteristics

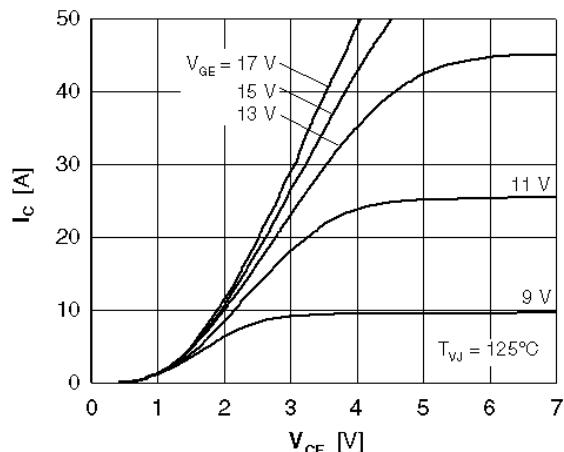


Fig. 2 Typ. output characteristics

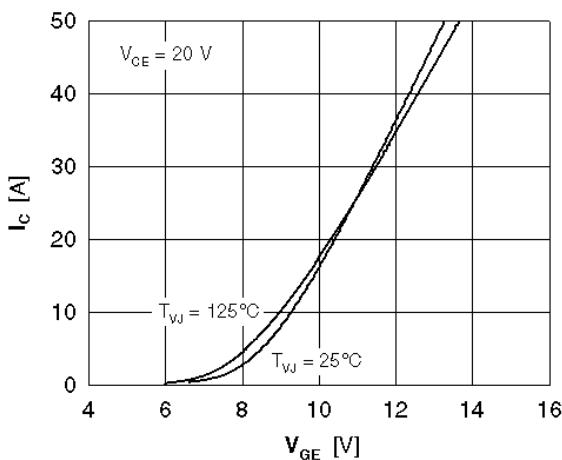


Fig. 3 Typ. transfer characteristics

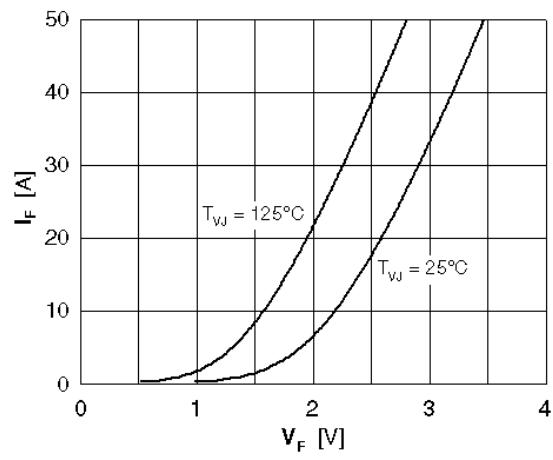


Fig. 4 Typ. forward characteristics of free wheeling diode

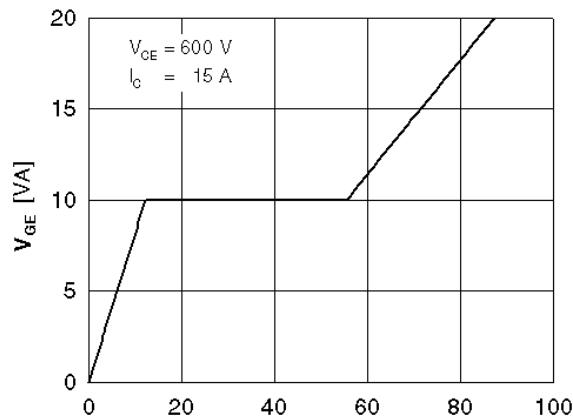


Fig. 5 Typ. turn on gate charge

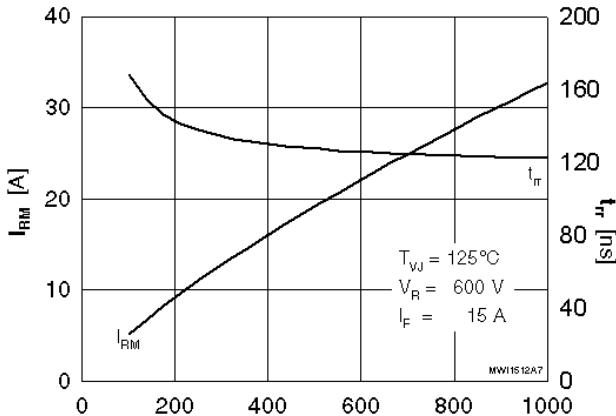


Fig. 6 Typ. turn off characteristics of free wheeling diode

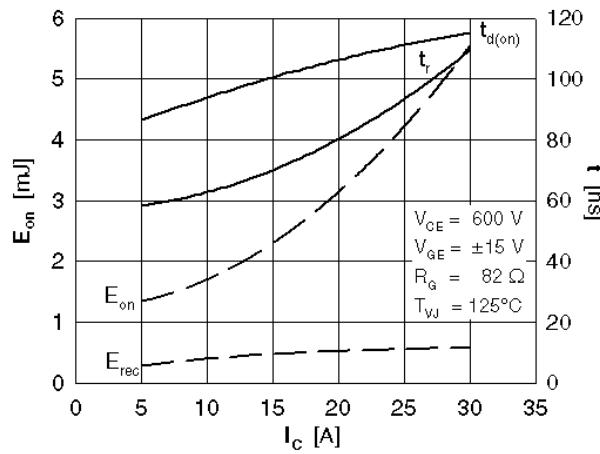


Fig. 7 Typ. turn on energy and switching times versus collector current

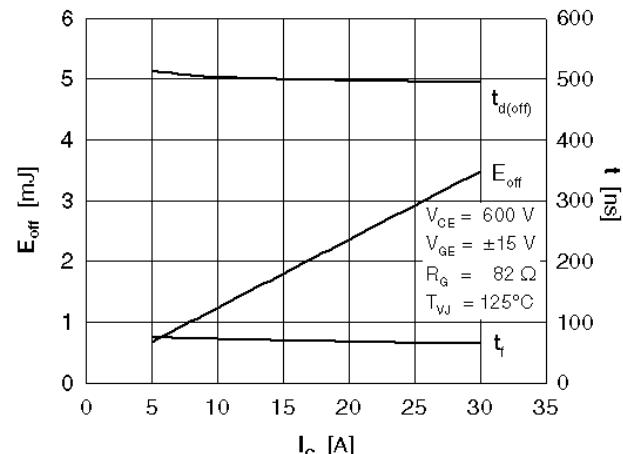


Fig. 8 Typ. turn off energy and switching times versus collector current

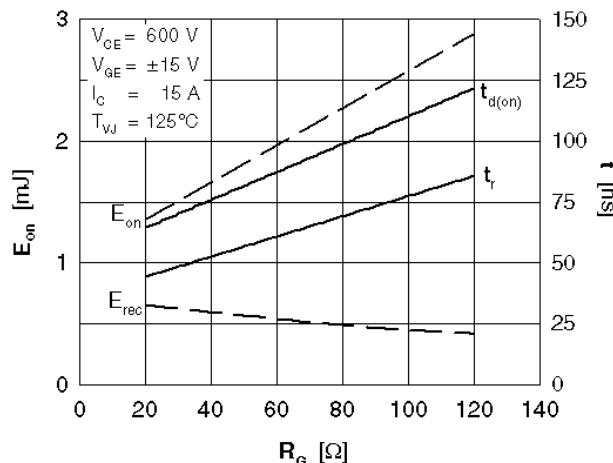


Fig. 9 Typ. turn on energy and switching times versus gate resistor

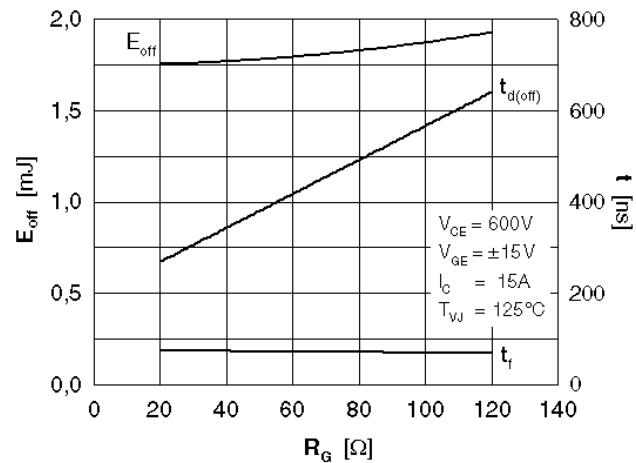


Fig. 10 Typ. turn off energy and switching times versus gate resistor

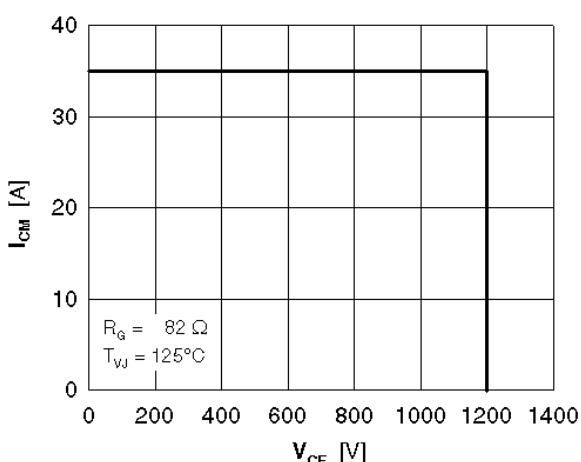


Fig. 11 Reverse biased safe operating area

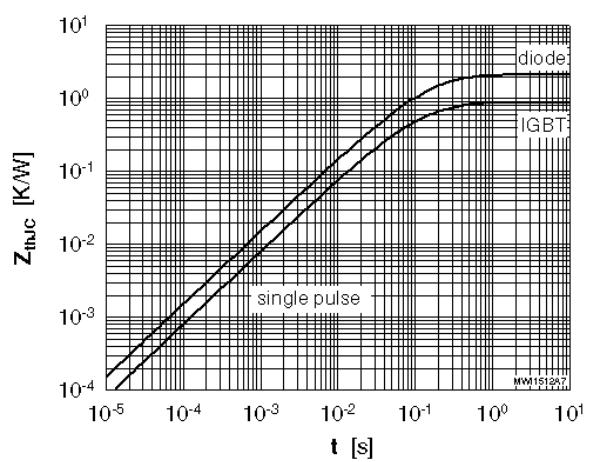


Fig. 12 Typ. transient thermal impedance